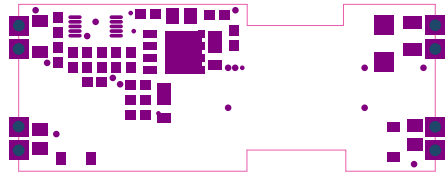
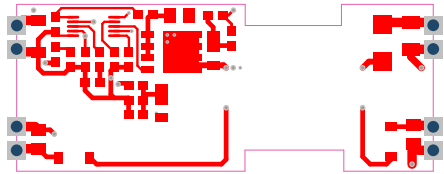


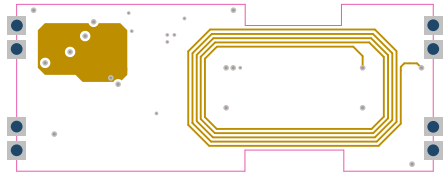
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: PMP40100		
PLOT NAME = Top Overlay	GENERATED : 11/25/2016 5:14:48 PM	TEXAS INSTRUMENTS	



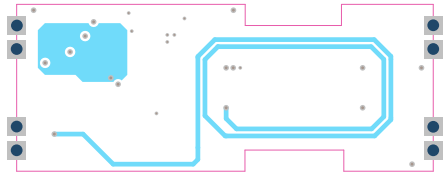
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: PMP40100		
PLOT NAME = Top Solder Mask	GENERATED : 11/25/2016 5:14:49 PM	TEXAS INSTRUMENTS	



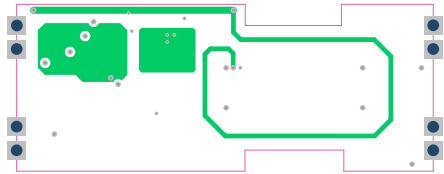
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: PMP40100		
PLOT NAME = Top Layer	GENERATED : 11/25/2016 5:14:50 PM	TEXAS INSTRUMENTS	



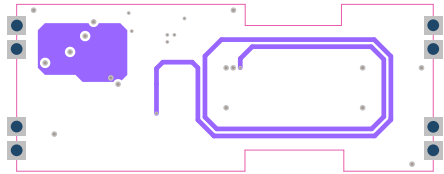
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SVN REV: Not In VersionControl
LAYER NAME =	TID #: PMP40100		
PLOT NAME = Signal Layer 1	GENERATED : 11/25/2016 5:14:50 PM	TEXAS INSTRUMENTS	



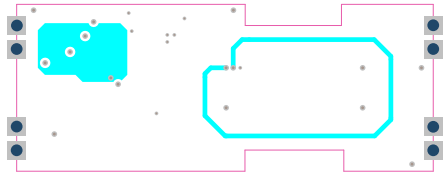
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SVN REV: Not In VersionControl
LAYER NAME =	TID #: PMP40100		
PLOT NAME = Signal Layer 2	GENERATED : 11/25/2016 5:14:51 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SVN REV: Not In VersionControl
LAYER NAME =	TID #: PMP40100		
PLOT NAME = Signal Layer 3	GENERATED : 11/25/2016 5:14:52 PM	TEXAS INSTRUMENTS	

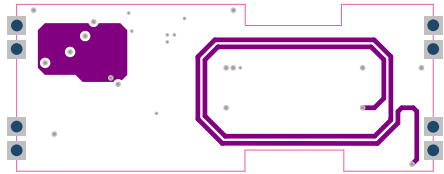


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SUN REV: Not In VersionControl
LAYER NAME =	TID #: PMP40100		
PLOT NAME = Signal Layer 4	GENERATED : 11/25/2016 5:14:52 PM	TEXAS INSTRUMENTS	

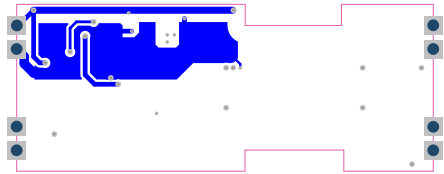


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SVN REV: Not In VersionControl
LAYER NAME =	TID #: PMP40100		
PLOT NAME = Signal Layer 5	GENERATED : 11/25/2016 5:14:53 PM	TEXAS INSTRUMENTS	

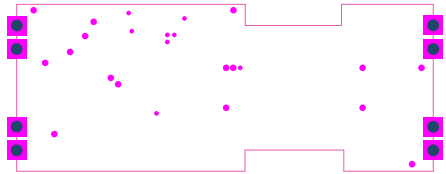




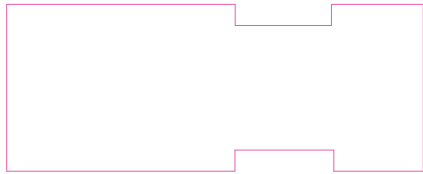
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SVN REV: Not In VersionControl
LAYER NAME =	TID #: PMP40100		
PLOT NAME = Signal Layer 6	GENERATED : 11/25/2016 5:14:54 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: PMP40100		
PLOT NAME = Bottom Layer	GENERATED : 11/25/2016 5:14:54 PM	TEXAS INSTRUMENTS	

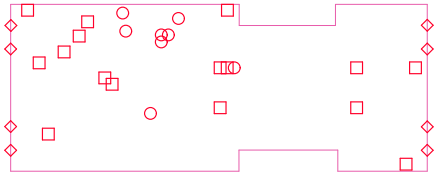


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: PMP40100		
PLOT NAME = Bottom Solder Mask	GENERATED : 11/25/2016 5:14:55 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: PMP40100		
PLOT NAME = Bottom Overlay	GENERATED : 11/25/2016 5:14:56 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
○	8	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer	
□	16	12.00mil (0.305mm)	PTH	Round	Top Layer - Bottom Layer	
◇	8	50.00mil (1.270mm)	PTH	Round	Top Layer - Bottom Layer	
	32 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: PMP40100		
PLOT NAME = Drill Drawing	GENERATED : 11/25/2016 5:14:56 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: PMP40100	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: PMP40100		
PLOT NAME = Board Dimensions	GENERATED : 11/25/2016 5:14:57 PM	TEXAS INSTRUMENTS	

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